



## Surface Mount Schottky Rectifier

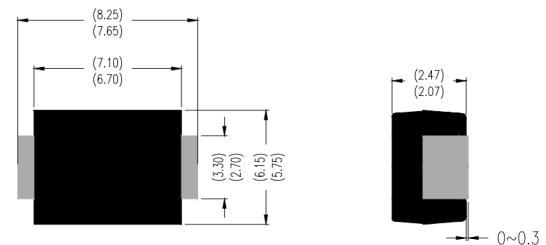
### Features

- Guardring for overvoltage protection
- Low power loss
- Extremely fast switching
- High forward surge capability
- High frequency operation
- Solder dip 260 °C max. 10 s, per JESD 22-B106

### Typical Applications

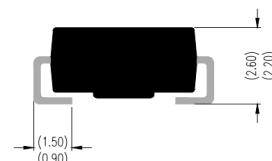
For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

DO-214AB (SMC)



### Mechanical Data

- **Package:** DO-214AB (SMC)  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Color band denotes the cathode end



### ■ Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS82	SS84	SS86	SS810	SS815	SS820
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	V	20	40	60	100	150	200
Average Rectified Output Current @60Hz sine wave, Resistance load, Ta (FIG.1)	I <sub>O</sub>	A			8.0			
Surge(Non-repetitive)Forward Current @60Hz Half-sine wave, 1 cycle, Ta=25°C	I <sub>FSM</sub>	A			120			
Storage Temperature	T <sub>stg</sub>	°C			-55 ~+150			
Junction Temperature	T <sub>j</sub>	°C		-55 ~+150		-55 ~+175		

### ■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS82	SS84	SS86	SS810	SS815	SS820
Maximum instantaneous forward voltage drop per diode	V <sub>F</sub>	V	I <sub>FM</sub> =8.0A	0.55	0.70	0.85	0.95		
Maximum DC reverse current at rated DC blocking voltage per diode	I <sub>R</sub>	mA	Ta=25°C		0.2		0.1		
			Ta=100°C		20		5.0		
Typical junction capacitance	C <sub>j</sub>	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C.	450	350	270	180		



■ Thermal Characteristics ( $T_a=25^\circ\text{C}$  Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	SS82	SS84	SS86	SS810	SS815	SS820
Thermal Resistance	Between junction and ambient	$R_{\theta J-A}$	°C/W	45 <sup>(1)</sup>					
	Between junction and lead	$R_{\theta J-L}$		12 <sup>(1)</sup>					

Note (1)

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas

■ Characteristics (Typical)

FIG.1:  $I_o$ -TL Curve

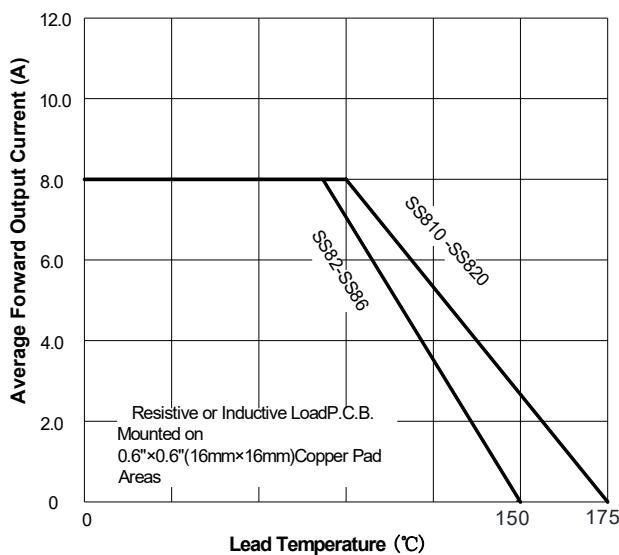


FIG.2: Forward Surge Current Capability

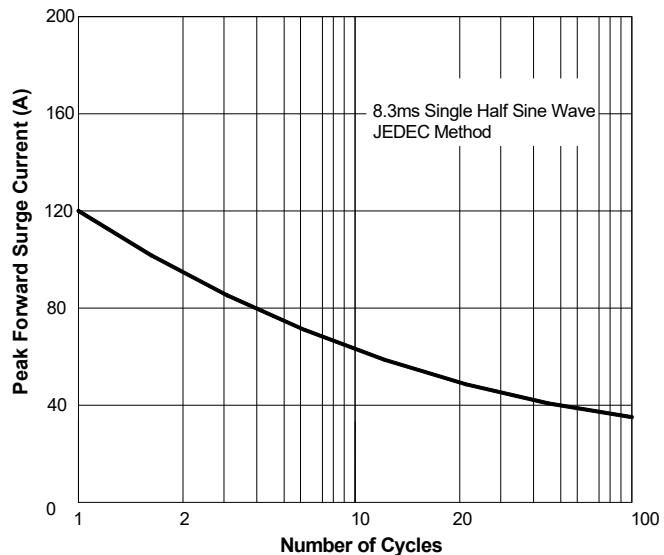


FIG.3: Forward Voltage

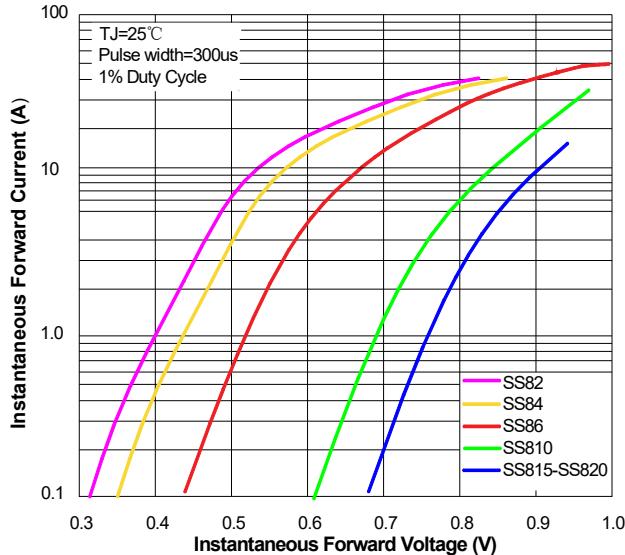


FIG.4: Typical Reverse Characteristics

